

# WP3SLSPO ☆

## WP3 SPO 061W8 250Mhz,LFballs,PBFbump,CAP

Status: In Production.

Documentation

Symbols

Microsemi's WinPath3-SuperLite (WP3-SL) provides a powerful, yet lower cost WinPath3 solution for access processing in the wireline and wireless access infrastructure equipment market. This new family of devices leverages Microsemi's broad portfolio of hardened market-ready protocols and industry preferred I/O interfaces and provides this solution in devices priced less than previous WinPath devices. It has the same processing elements as the WinPath3, but a reduced number (six) running up to 400 MHz. These processing elements support the latest packet based protocols such as Ethernet, PWE3 (for Ethernet TDM, HDLC, ATM), and Packet Network Synchronization (IEEE1588v2, Synchronous Ethernet, adaptive and differential clock recovery). It

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#### **Product Features**

- Next generation of access processors providing up to 2x the performance and more integration than the previous WinPath2 family
- Numerous WAN and LAN interfaces are supported in the family including 6 Gigabit Ethernet, 24 Fast Ethernet, 16 TDM and dual SPI-3/POS level 2/Utopia Level 2
- Wide range of bus interfaces available including PCIe plus

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#### **RoHS Information**

| Skip to footer        |               |                |          |     |
|-----------------------|---------------|----------------|----------|-----|
| WP3061W8NHEI-250B1 e1 | <b>√</b> RoHS | Not Applicable | <b>©</b> | 0.0 |
| WP3061W1NHEI-250B1 e1 | <b>√</b> КоНS | Not Applicable | <b>©</b> | 0.0 |

2 of 2 results

To see a complete listing of RoHS data for this device, please **Click here**Shipping Weight = Device Weight + Packing Material weight. Please **contact sales** office if device weight is not available.

### **Purchase from Microchip**

|                                      | Product Details        | Specifications  | Pricing QUANTITY USD | Production Availabil  |
|--------------------------------------|------------------------|---|----------------------|---|
| product image of WP3061W8NHEI-250B1  | WP3061W8NHEI-<br>250B1 | Pins   Packaging: 528   HBFBG<br>Temp Range: -40C to +85C<br>Packing Media: Tray (84) |                      | Available To Order  Order now, estimated to ship of Quantity:  Multiples of 84  Request prototype units for                                   |
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